

10/088996

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PATENT NUMBER and  
ISSUE DATE

## U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10088996	03/26/2002	100 324	236	1713 1765	LEE
<b>**APPLICANTS:</b> Arikawa Hideo; Tokita Suguru; 1713					
<b>**CONTINUING DATA VERIFIED:</b> THIS APPLICATION IS A 371 OF PCT/JP01/06497 07/27/2001					
<b>** FOREIGN APPLICATIONS VERIFIED:</b> JAPAN 2000-230765 07/31/2000 JAPAN 2000-379152 12/13/2000					
PG-PUB		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials				ATTORNEY DOCKET NO ZU-412	
TITLE : Aqueous dispersion composition for imparting chipping resistance					
U.S. DEPT. OF COMM. / PAT. & TM-PTO-436L (Rev. 12-94)					

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<b>NOTICE OF ALLOWANCE MAILED</b>		<b>CLAIMS ALLOWED</b>	
		Total Claims	Print Claim for O.G.
<b>ISSUE FEE</b>		<b>DRAWING</b>	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. Print Fig.
<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>		Application Examiner	
		<b>PREPARED FOR ISSUE</b>	
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